

# 74VHC125 Quad Buffer with 3-STATE Outputs

#### Features

- High Speed: t<sub>PD</sub> = 3.8ns (Typ.) at V<sub>CC</sub> = 5V
- Lower power dissipation:  $I_{CC} = 4 \ \mu A$  (Max.) at  $T_A = 25^{\circ}C$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (Min.)
- Power down protection is provided on all inputs
- Low noise: V<sub>OLP</sub> = 0.8V (Max.)
- Pin and function compatible with 74HC125

## **General Description**

The VHC125 contains four independent non-inverting buffers with 3-STATE outputs. It is an advanced highspeed CMOS device fabricated with silicon gate CMOS technology and achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

An input protection circuit insures that 0V to 7V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Ordering Information**

Order Number	Package Number	Package Description
74VHC125M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHC125MX_NL <sup>(1)</sup>	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VHC125SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC125MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC125MTCX_NL <sup>(1)</sup>	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

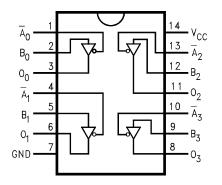
Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering number. Pb-Free package per JEDED J-STD-020B.

#### Note:

1. Device available in Tape and Reel only.

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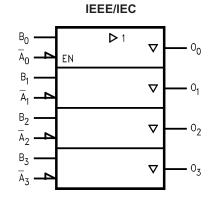
#### **Connection Diagram**



# **Pin Description**

Pin Names	Description
Ā <sub>n</sub> , B <sub>n</sub>	Inputs
O <sub>n</sub>	Outputs

## Logic Symbol



# **Function Table**

Inp	uts	Output
Ā <sub>n</sub>	B <sub>n</sub>	O <sub>n</sub>
L	L	L
L	Н	Н
Н	Х	Z

H = HIGH Voltage Level

L = LOW Voltage Level

Z = HIGH Impedance

X = Immaterial

#### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	-0.5V to +7.0V
V <sub>IN</sub>	DC Input Voltage	-0.5V to +7.0V
V <sub>OUT</sub>	DC Output Voltage	-0.5V to V <sub>CC</sub> + 0.5V
I <sub>IK</sub>	Input Diode Current	–20mA
I <sub>OK</sub>	Output Diode Current	±20mA
I <sub>OUT</sub>	DC Output Current	±25mA
I <sub>CC</sub>	DC V <sub>CC</sub> / GND Current	±50mA
T <sub>STG</sub>	Storage Temperature	–65°C to +150°C
TL	Lead Temperature (Soldering, 10 seconds)	260°C

# Recommended Operating Conditions<sup>(2)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	2.0V to +5.5V
V <sub>IN</sub>	Input Voltage	0V to +5.5V
V <sub>OUT</sub>	Output Voltage	0V to V <sub>CC</sub>
T <sub>OPR</sub>	Operating Temperature	–40°C to +85°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time,	
	$V_{CC} = 3.3V \pm 0.3V$	0ns/V ~ 100ns/V
	$V_{CC} = 5.0V \pm 0.5V$	0ns/V ~ 20ns/V

Note:

2. Unused inputs must be held HIGH or LOW. They may not float.

					<b>T</b> <sub>A</sub> =						
					25°C			-40°C to +85°C			
Symbol	Parameter			Conditions Min.		Тур.	Max.	Min.	Max.	Units	
V <sub>IH</sub>	HIGH Level Input	2.0			1.50			1.50		V	
	Voltage	3.0–5.5			$0.7 \times V_{CC}$			0.7 x V <sub>CC</sub>			
$V_{IL}$	LOW Level Input	2.0					0.50		0.50	V	
	Voltage	3.0–5.5					0.3 x V <sub>CC</sub>		$0.3 \times V_{CC}$		
	HIGH Level Output Voltage	2.0		I <sub>OH</sub> =50μA	1.9	2.0		1.9		V	
		3.0	or V <sub>IL</sub>		2.9	3.0		2.9			
		4.5	]		4.4	4.5		4.4			
		3.0		I <sub>OH</sub> = -4mA	2.58			2.48			
		4.5		I <sub>OH</sub> = -8mA	3.94			3.80			
V <sub>OL</sub>	LOW Level Output Voltage	2.0	$V_{IN} = V_{IH}$	I <sub>OL</sub> = 50μA		0.0	0.1		0.1	V	
		3.0	or V <sub>IL</sub>			0.0	0.1		0.1		
		4.5				0.0	0.1		0.1		
		3.0	]	$I_{OL} = 4mA$			0.36		0.44		
		4.5	]	I <sub>OL</sub> = 8mA			0.36		0.44		
I <sub>OZ</sub>	3-STATE Output Off-State Current	5.5	$V_{IN} = V_{IH} c$ $V_{OUT} = V_C$				±0.25		±2.5	μA	
I <sub>IN</sub>	Input Leakage Current	0–5.5	$V_{IN} = 5.5V \text{ or GND}$				±0.1		±1.0	μA	
I <sub>CC</sub>	Quiescent Supply Current	5.5	$V_{IN} = V_{CC}$	or GND			4.0		40.0	μA	

## **Noise Characteristics**

				T <sub>A</sub> =	= 25°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Тур.	Limits	Units
V <sub>OLP</sub> <sup>(3)</sup>	Quiet Output Maximum Dynamic V <sub>OL</sub>	5.0	$C_L = 50 pF$	0.5	0.8	V
V <sub>OLV</sub> <sup>(3)</sup>	Quiet Output Minimum Dynamic V <sub>OL</sub>	5.0	$C_L = 50 pF$	-0.5	-0.8	V
V <sub>IHD</sub> <sup>(3)</sup>	Minimum HIGH Level Dynamic Input Voltage	5.0	$C_L = 50 pF$		3.5	V
V <sub>ILD</sub> <sup>(3)</sup>	Maximum HIGH Level Dynamic Input Voltage	5.0	$C_L = 50 pF$		1.5	V

#### Note:

3. Parameter guaranteed by design.

## AC Electrical Characteristics

					т	<sub>A</sub> = 25°	с		–40°C 85°C	
Symbol	Parameter	$V_{CC}(V)$	Cond	litions	Min.	Тур.	Max.	Min.	Max.	Units
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay	3.3 ± 0.3		$C_L = 15 pF$		5.6	8.0	1.0	9.5	ns
	Time			$C_L = 50 pF$		8.1	11.5	1.0	13.0	
		5.0 ± 0.5		$C_L = 15 pF$		3.8	5.5	1.0	6.5	ns
				$C_L = 50 pF$		5.3	7.5	1.0	8.5	
t <sub>PZL</sub> , t <sub>PZH</sub>	3-STATE Output	3.3 ± 0.3	$R_L = 1k\Omega$	$C_L = 15 pF$		5.4	8.0	1.0	9.5	ns
	Enable Time			$C_L = 50 pF$		7.9	11.5	1.0	13.0	
		5.0 ± 0.5		$C_L = 15 pF$		3.6	5.1	1.0	6.0	ns
				$C_L = 50 pF$		5.1	7.1	1.0	8.0	
t <sub>PLZ</sub> , t <sub>PHZ</sub>	3-STATE Output	3.3 ± 0.3	$R_L = 1k\Omega$	$C_L = 50 pF$		9.5	13.2	1.0	15.0	ns
	Disable Time	5.0 ± 0.5		$C_L = 50 pF$		6.1	8.8	1.0	10.0	
t <sub>OSLH</sub> , t <sub>OSHL</sub>	Output to Output	3.3 ± 0.3	(4)	$C_L = 50 pF$			1.5		1.5	ns
	Skew	5.0 ± 0.5		$C_L = 50 pF$			1.0		1.0	
C <sub>IN</sub>	Input Capacitance		V <sub>CC</sub> = Ope	en		4	10		10	pF
C <sub>OUT</sub>	Output Capacitance		$V_{CC} = 5.0^{\circ}$	V		6				pF
C <sub>PD</sub>	Power Dissipation Capacitance		(5)			14				pF

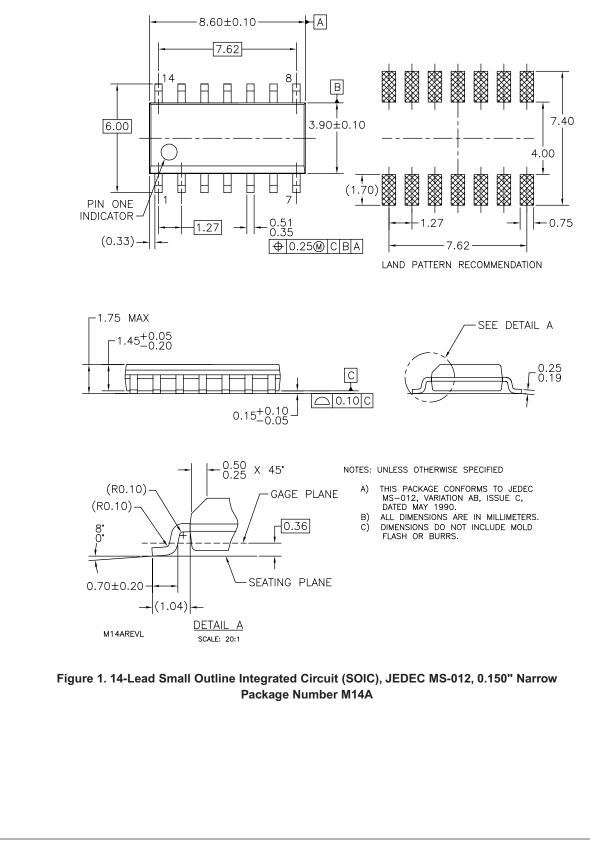
#### Notes:

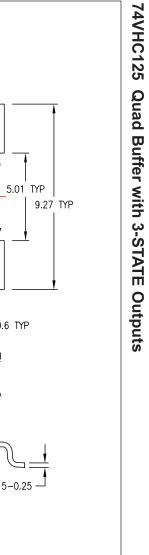
4. Parameter guaranteed by design.  $t_{OSLH} = |t_{PLHmax} - t_{PLHmin}|; t_{OSHL} = |t_{PHLmax} - t_{PHLmin}|.$ 

5.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC}$  (Opr.) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 4$  (per bit).

#### **Physical Dimensions**

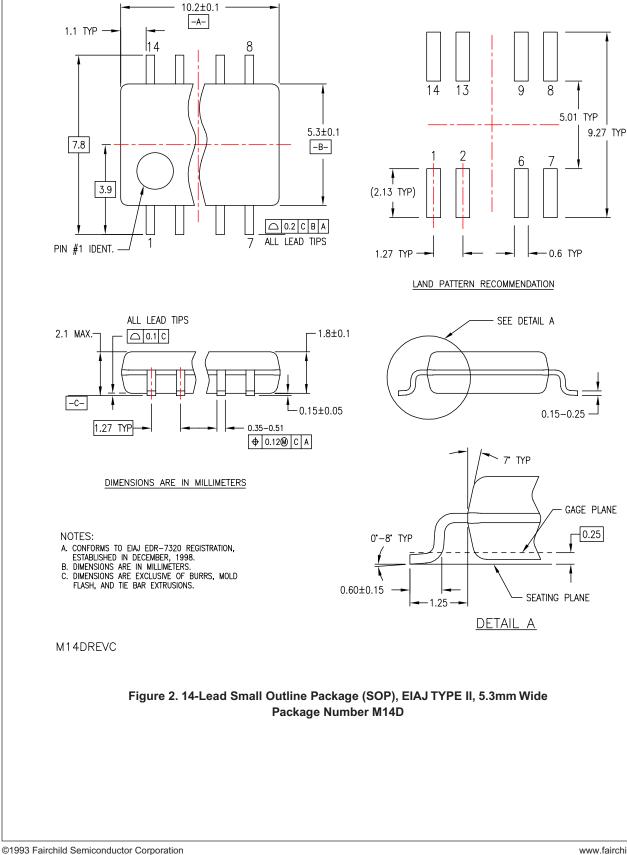
Dimensions are in millimeters unless otherwise noted.





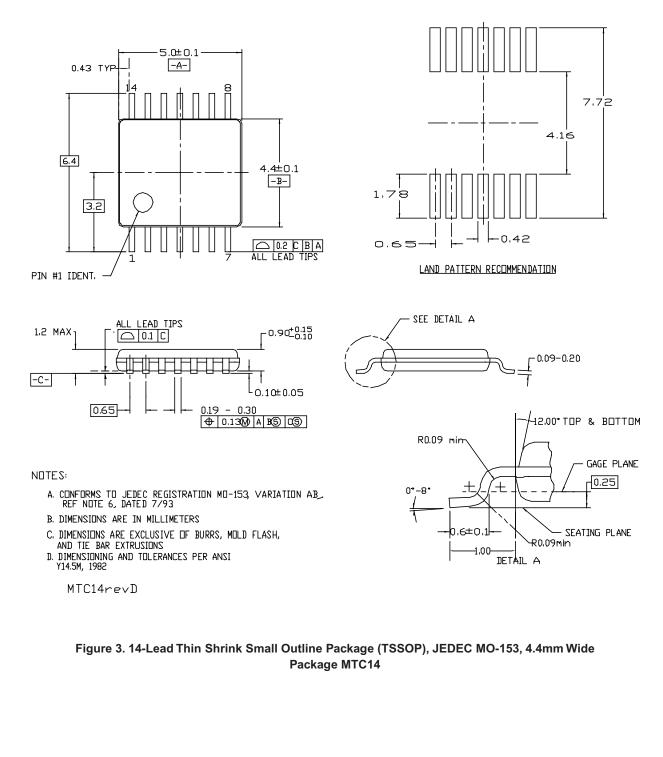
#### Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.





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